

Title (en)

METHOD FOR IMPROVING THE ADHESION OF PLATED METAL LAYERS TO SILICON

Title (de)

VERFAHREN ZUR VERBESSERUNG DER HAFTUNG VON PLATTIERTEN METALLSCHICHTEN AUF SILICIUM

Title (fr)

PROCÉDÉ D'AMÉLIORATION DE L'ADHÉSION DE COUCHES DE MÉTAL PLAQUÉ SUR DU SILICIUM

Publication

**EP 2896070 A2 20150722 (EN)**

Application

**EP 13753849 A 20130822**

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- EP 2013067450 W 20130822

Abstract (en)

[origin: WO2014040834A2] A method is disclosed for fabricating photovoltaic cells, the method comprising providing plated metal contacts with a contact pattern comprising a plurality of fingers and at least one first pinning element at the free ends of each of the plurality of fingers; and associated photovoltaic cells.

IPC 8 full level

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CPC (source: CN EP)

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Citation (search report)

See references of WO 2014040834A2

Cited by

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